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ON Semiconductor®

FDC655BN

Single N-Channel, Logic Level, PowerTrench[®] MOSFET 30 V, 6.3 A, 25 m Ω

Features

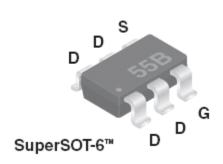
- Max $r_{DS(on)}$ = 25 m Ω at V_{GS} = 10 V, I_D = 6.3 A
- Max $r_{DS(on)}$ = 33 m Ω at V_{GS} = 4.5 V, I_D = 5.5 A
- Fast switching
- Low gate charge
- High performance trchnology for extremely low r_{DS(on)}
- Termination is Lead-free and RoHS Compliant

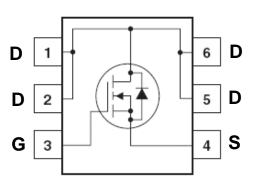


General Description

This N-Channel Logic Level MOSFET is produced using ON Semiconductor's advanced PowerTrench[®] process that has been especially tailored to minimize the onstate resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage			±20	V	
1	-Continuous	$T_A = 25^{\circ}C$	(Note 1a)	6.3	٨	
D	-Pulsed			20	Α	
D	Power Dissipation (Note 1a)		(Note 1a)	1.6		
P _D	Power Dissipation (Note 1b)		(Note 1b)	0.8		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to + 150	°C	

Thermal Characteristics

$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	78	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.55B	FDC655BN	SSOT-6 [™]	7 "	8 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	30			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25°C		25		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20$ V, $V_{DS} = 0$ V			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25° C		-5		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 6.3 A		21	25	
		V _{GS} = 4.5 V, I _D = 5.5 A		26	33	mΩ
		$V_{GS} = 10 V, I_{D} = 6.3 A, T_{J} = 125^{\circ}C$		30	36	7
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 6.3 A		35		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			470	620	pF
C _{oss}	Output Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1MHz		100	130	pF
C _{rss}	Reverse Transfer Capacitance	1 - 11/11/2		60	90	pF
R _g	Gate Resistance			3.0		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			6	11	ns
t _r	Rise Time	V _{DD} = 15 V, I _D = 1 A,		2	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		15	26	ns
t _f	Fall Time			2	10	ns
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		9	13	nC
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 15 V,$		5	7	nC
Q _{gs}	Gate to Source Charge	I _D = 6.3 A		1.4		nC
Q _{gd}	Gate to Drain "Miller" Charge			1.6		nC

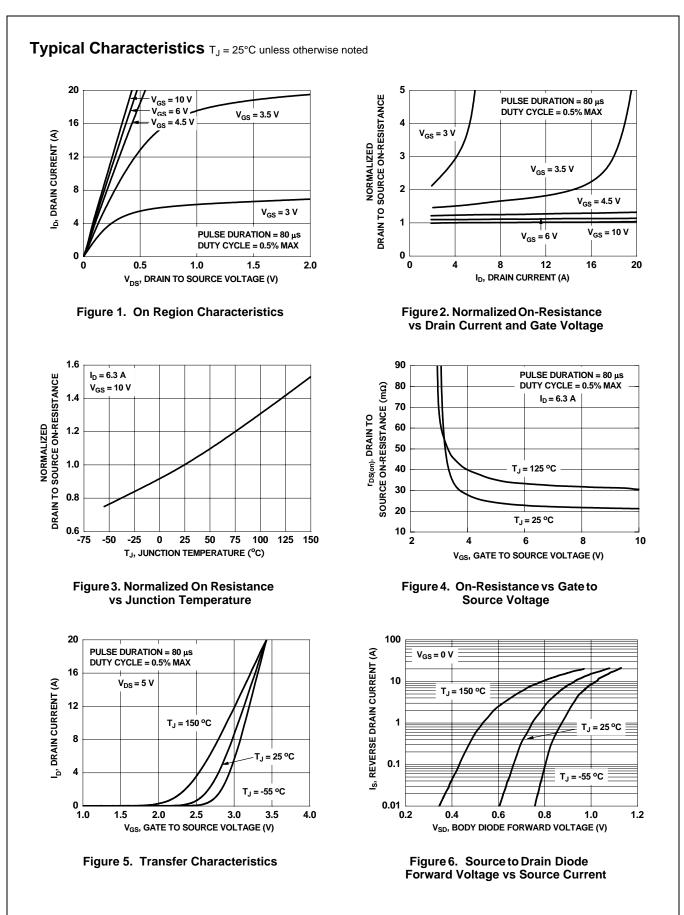
I _S	Maximum Continuous Drain-Source Diode Forward Current			1.3	А
V _{SD}	Source-Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 1.3 A (Note 2)	0.8	1.2	V
t _{rr}	Reverse Recovery Time	I _E = 6.3 A, di/dt = 100 A/μs	15	26	ns
Q _{rr}	Reverse Recovery Charge	$F = 0.5 \text{ A}, \text{ u/dt} = 100 \text{ A/} \mu \text{s}$	4	10	nC

Notes:

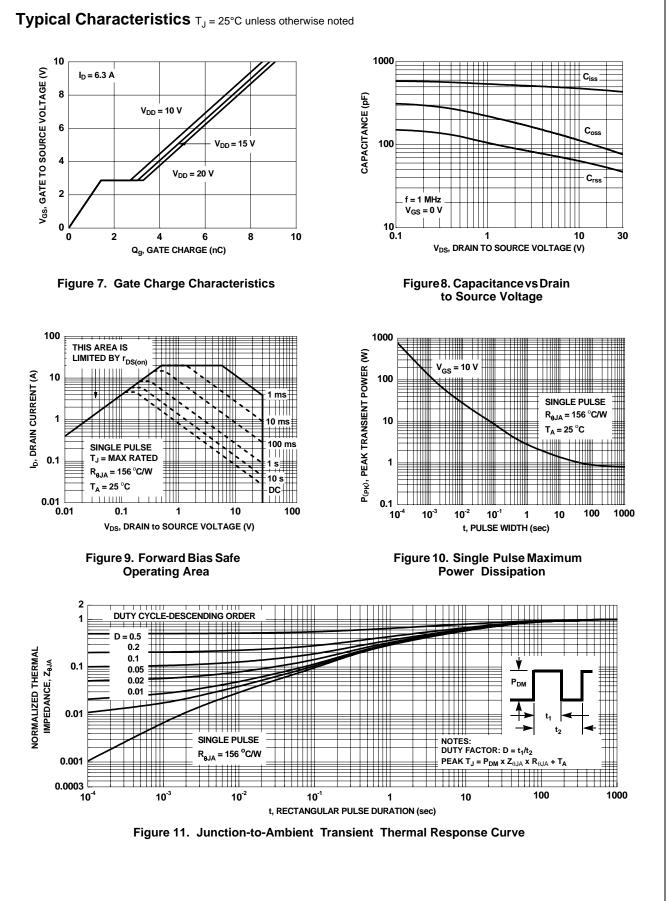
 $R_{0,LA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{0,LC}$ is guaranteed by design while $R_{0,CA}$ is determined by the user's board design.

a. 78 °C/W when mounted on a 1 in² pad of 2 oz copper on FR-4 board. b. 156 °C/W when mounted on a minimum pad.

2: Pulse Test: Pulse Width<300 us, Duty Cycle<2.0%.



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